Lithium-Ion (de)insertion reaction of Germanium thin-film electrodes: an electrochemical and in situ XRD study

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Nowadays there is a growing need for high storage capacity and high power density solid-state lithium-ion microbatteries.\(^1,4\) Indeed, future medical implants and other crucial upcoming applications will require small and power-dense portable energy supplies. Obviously, the electrode materials of such a battery should be able to store a large amount of Li while maintaining a good cyclability and high rate capability.

Negative electrodes of existing planar solid-state thin-film lithium-ion batteries usually consist of pure metallic lithium.\(^2,3\) The rate capability of lithium is very high in comparison with alloying materials. However, others issues, such as safety and packaging, should be improved. At the moment, many groups are investigating suitable Li-ion negative electrode materials for bulk and thin-film applications, for example, silicon-, germanium- and tin-based materials.\(^4\) These group-IV materials are ideal candidates with respect to storage capacity, as they can store more than 7000 mAh cm\(^{-3}\) of the starting material. Moreover, silicon and germanium thin films have demonstrated a high rate capability.\(^5,6\)

The Li-ion electrochemistry of silicon-based electrodes has been thoroughly studied.\(^2,4,11-25\) Germanium electrodes have received little attention in the existing literature because of the high cost of the material.\(^6,10\) However, for application in thin-film batteries the amount of electrode material is not a critical issue. Moreover, germanium presents several advantages over silicon, such as a two orders of magnitude higher diffusivity for lithium and a four orders of magnitude higher electronic conductivity.\(^5,10\) Germanium has mainly been studied toward electrochemical potential profiles, capacity retention, rate capability, and crystallographic phase transitions.\(^5,6,10,26-30\) This material could be a suitable negative electrode material for all-solid-state Li-ion thin-film batteries.\(^5,6,10\) Moreover, Graetz et al. attempted to identify the crystallographic phases formed upon (de)inserting germanium thin-films using ex situ X-ray diffraction (XRD). However, these attempts were unfortunately unsuccessful.\(^6\)

Recently, two other groups studied the phase transitions of Ge-based bulk electrodes with ex situ XRD.\(^3,36\) The first group focused on the fully lithiated electrode material and found evidence for the crystallization of germanium into cubic Li\(_{15}\)Ge\(_4\) as an end member of the electrochemically induced Li–Ge system.\(^3,35\) This result is very similar to that of silicon, which crystallizes into cubic Li\(_{15}\)Si\(_4\).\(^3,35\)

The second group investigated Ge-based bulk electrodes as a function of the Li composition also by means of ex situ XRD.\(^10\) They clearly revealed the formation of Li\(_{15}\)Ge\(_4\) but also reported supporting evidence of the formation of other Li–Ge phases on the basis of a few diffraction peaks only. For the fully loaded electrode, the formation of Li\(_{15}\)Ge\(_4\) was supported by a single diffraction peak at \(2\theta = 40.6^\circ\). This is rather ambiguous as the positions of the strongest calculated diffraction peak for Li\(_{15}\)Ge\(_4\) and Li\(_{22}\)Ge\(_5\) are the same, at exactly \(2\theta = 40.65^\circ\) (Pauling File Binaries edition, Data sheets S1250775 and S457785, respectively for Li\(_{22}\)Ge\(_5\) and Li\(_{15}\)Ge\(_4\)). Moreover, both studies were conducted ex situ and no particular precaution toward air and water was reported in the corresponding experimental sections.

Using a sealed cell to determine the phase transformations of germanium during (de)lithiation by means of in situ XRD offers several advantages over the setups employed by other groups. First, air and water contamination are prevented. Moreover, by adopting thin layers of pure germanium, the electrochemical control of the Li–Ge stoichiometry is much more accurate. Indeed, opposite to bulk composite electrodes, no binders or conductive additives interfering with the desired Li–Ge reaction are employed.

In this paper, we report on various aspects of the Li (de)insertion of germanium thin-film electrodes. The reactions observed when inserting/extracting lithium into/from evaporated germanium will be discussed. The thermodynamic and kinetic properties were electrochemically measured by using cyclic voltammetry (CV) and the galvanostatic intermittent titration technique (GITT), coupled with electrochemical impedance spectroscopy (EIS). In addition, in situ electrochemical XRD of evaporated germanium thin layers will be presented. Moreover, it has been found that sputtered germanium reveals different electrochemical properties than evaporated germanium, which might be related to a different reaction mechanism. In situ XRD will therefore also be presented for sputtered germanium films.

**Experimental**

*Thin-film deposition.—* Two electrochemical measurement setups were employed. The first setup was used to determine the electrochemical characteristics of germanium thin films, while the second setup served the in situ electrochemical XRD measurements. For both setups, the germanium thin films were grown using the same deposition conditions.
The first setup employed n++ silicon substrates covered by 70 nm of titanium nitride. In this configuration, titanium nitride was used as a current collector and Li-diffusion barrier layer. Subsequently, 50 nm thick germanium layers were deposited by either sputtering or evaporation.

The in situ XRD setup used XRD-amorphous poly-etheretherketone (PEEK) foils of 125 μm thickness as substrates (GoodFellow). Prior to the deposition of titanium nitride and germanium, a thin titanium layer of 3 nm was sputtered onto the PEEK foil. This layer was used as an adhesion layer for the subsequently deposited materials. As this film is rather thin, no interfering diffraction lines are expected from titanium. Titanium adhesion layers were sputtered in a Vtec Nexus 800 chamber. The base pressure was 6.7 × 10⁻⁸ mbar. Using a 12 in. titanium target, 100 W dc power, a deposition pressure of 2.6 × 10⁻⁷ mbar, and an Ar flow of 50 sccm, titanium was deposited at 0.13 Å s⁻¹. Then, a titanium nitride film of 200 nm was grown on top of the titanium film by reactive sputtering in a nitrogen plasma, using conditions reported elsewhere. Finally, germanium films from 100 to 800 nm were either evaporated or sputtered on top of the titanium nitride. Using an E-beam evaporation tool (Bak550 from Balzers, Liechtenstein) at a base pressure of 10⁻⁸ mbar and a deposition pressure of 4 × 10⁻⁷ mbar, germanium thin films were evaporated at a rate of 2 Å s⁻¹. Using a sputtering tool from Emerald at a base pressure of 10⁻⁷ mbar, a deposition pressure of 5.2 × 10⁻⁸ mbar, and an Ar flow of 70 sccm, germanium thin films were sputtered from an 8 in. germanium target with a radio-frequency power of 200 W at a rate of 0.5 Å s⁻¹.

**Electrochemical characterization.**—For both electrochemical setups, the germanium electrodes were mounted as working electrodes while pure lithium foils were used as counter and reference electrodes. A liquid electrolyte, comprising 1 M LiClO₄ dissolved in propylene carbonate (Puriel, Techno Semichem Co. Ltd., Korea) was used. All electrochemical measurements were conducted with Autolab PGSTAT30 equipment (Ecochemie B.V., Utrecht, The Netherlands). The following convention is adopted throughout the article: charging the electrode material refers to Li insertion and discharging to Li extraction. All potentials are written with respect to Li/Li⁺ standard redox potential.

The first setup employed a three-electrode cylindrical cell, made of Teflon having a volume of about 40 mL. The circular germanium electrodes (φ = 2 cm²) were assembled in an argon-filled glove box with water and oxygen content below 1 ppm. The cells were placed in a stainless steel holder that was thermostatically controlled at 25°C. This setup was used to determine the equilibrium voltage curves and the electrode impedance of germanium electrodes, using GITT and EIS, respectively, and cyclic voltammograms. GITT was performed by applying approximately 40 successive increments of charge at a 1 C rate, followed by intermediate rests of 1.5 h. Two cutoff potentials were applied during the galvanostatic steps of the GITT, i.e., 50 and 0 mV. EIS was performed after each GITT resting period, using an excitation voltage of 5 mV amplitude within a frequency range of 100 kHz and 100 mHz. The impedance results were fitted using an equivalent circuit software tool. CV was performed at a scan rate of 50 µV s⁻¹ between 0 and 1 or 2 V.

The in situ XRD setup comprised a specially designed cell made of poly(vinylidene fluoride). The body of the cell is identical to that of Vermeulen et al. Insides an argon-filled glove box, a PEEK foil, covered with the previously described layers, was attached to one side of the cell body. Then, the body was filled with the same electrolyte described above. The foil attachment system ensured a proper electrical contacting of the germanium films via a copper ring, which is sealed from the electrolyte with an O-ring. Subsequently, pure lithium foils (Sigma Aldrich) were attached to crocodile clamps placed under a newly designed cover and introduced in the solution. Very thin metallic wires, soldered to the crocodile clamps, allowed the external electrical contacting of the lithium foils as reference and counter electrodes. Finally, the cover of the cell was placed and sealed by means of an additional O-ring in the same way used by Vermeulen et al.

**XRD experiments.**—Ex situ XRD was measured on freshly deposited samples made of PEEK/Ti/Ge germanium films using a Panalytical XPet Pro diffractometer equipped with a Cu source to generate Kα radiation (1.54 Å). The in situ electrochemical XRD cell was mounted on a Philips PW 1835 horizontal diffractometer. Gonio (0-2θ) scans were recorded using a Cu source to generate Kα radiation. Each in situ XRD scan was recorded from 18 to 54° in 75 min.

**Results and Discussion**

The crystallinity of the starting evaporated germanium material was measured with ex situ XRD on samples with different thickness. The main graph of Fig. 1 presents diffraction patterns for the 100, 200, and 800 nm films. No sharp peaks are visible, which indicates that evaporated germanium presents a disordered structure (amorphous). To eliminate the substrate background, the diffraction patterns of the thickest and thinnest layers were subtracted (inset of Fig. 1). As a consequence, broad peaks corresponding to the germanium diamond structure are observed. This result is similar to those reported by Laforge et al. for sputtered germanium films. It can be concluded that the starting evaporated material has a poor crystalline structure.

The electrochemical response of the evaporated germanium films was measured for different insertion cutoff potentials using CV at 50 µV s⁻¹. The results corresponding to 50 nm thick films are presented in Fig. 2. Several broad peaks are observed during reduction (insertion or charge) down to 300 mV, followed by a more pronounced peak at about 150 mV (blue curve). Further insertion of Li leads to a small and sharp peak around 50 mV (orange curve). During oxidation (deinsertion or discharge), reversible peaks are found for the phases formed down to 300 mV. The reduction peak at about 150 mV is, however, accompanied by a rather broad peak during delithiation (blue curve). Strikingly, the small peak at about 50 mV induces very sharp oxidation peaks at about 485 and 525 mV. For comparison, silicon reveals only two broad peaks when the material is lithiated until 50 mV, and upon further charging this system shows a small plateau representative of the crystallization into LiₓSi₄. During Li extraction from LiₓSi₄, a single peak response is observed. This situation is rather different from that of the evaporated germanium, where a double peak system is found.
A decrease of the current during both potentiostatic steps is found, and after the crystallization into Li$_{15}$Ge$_4$. The corresponding current responses are shown in the inset of Fig. 4. A decrease of the current during both potentiostatic steps is found, indicating that the insertion reactions proceed relatively rapidly. The corresponding XRD results are presented in the main graph of Fig. 4. The XRD patterns of the as-deposited (pink curve) and discharged (green curve) electrode are included as references. Taking a closer look at the pattern of the as-deposited sample, a strong (111) preferred orientation of the titanium nitride crystallites is found at $36.5^\circ$ 2$\Theta$. Interestingly, the discharged electrode reveals a weaker (111) intensity and a reflection of the [200] lattice planes is now visible at $42.5^\circ$ 2$\Theta$. The modification of the titanium nitride crystallites orientation probably results from the stress induced by the expansion/shrinkage of the germanium layer onto the underlying titanium nitride.

Laforge et al. only observed a single-peak response during the deinsertion of fully lithiated sputtered germanium thin films. To characterize the crystallographic phases formed during Li insertion, in situ XRD was conducted on 200 nm thick films. Figure 3a shows a typical potential profile obtained for evaporated germanium during the first insertion/extraction of Li. The electrode was charged with a constant current of about $1/25$ C rate followed by a resting period. Subsequently, the electrode was discharged at the same rate. A voltage plateau is clearly found around 1 V, which can be attributed to the formation of a solid electrolyte interphase (SEI) layer. Further charging leads to several sloping parts, which correspond to the small peaks found in the CVs of Fig. 2. Upon further lithiation, a large quasi-plateau is visible from 15 to 23 h, which corresponds to the pronounced peak in Fig. 2. At the end of the insertion process, a small plateau is found, which is analogous to the small and sharp peak observed at 50 mV in Fig. 2. During the extraction of Li from the fully lithiated germanium electrode, two plateaus can be discerned, corresponding to the two peaks reported above. Upon further extraction of Li, a steeper potential response is measured at higher voltages.

During the galvanostatic (dis)charging of the germanium electrode, XRD patterns were collected. The starting time of each diffraction pattern is indicated in the potential curve of Fig. 3a by markers. The corresponding patterns are plotted in Fig. 3b and c for insertion and deinsertion, respectively. The direction of Li insertion/extraction into/from the electrode material is indicated by the arrows. First, all patterns indicate a strong reflection peak at $36.5^\circ$ which corresponds to the (111) diffraction of titanium nitride. Moreover, the as-deposited material does not exhibit any clear sharp peaks related to germanium, as already concluded from the ex situ XRD patterns (Fig. 1). Upon insertion (Fig. 3b), no peaks are visible in the patterns until the potential reaches 110 mV, which corresponds to the small plateau visible at the very end of charging (Fig. 3a). The associated diffraction peaks match very well the reference pattern of cubic Li$_2$Ge$_2$. Upon deinsertion (Fig. 3c), the peaks associated with Li$_2$Ge$_2$ reduce in intensity and no peaks for other crystalline Li–Ge phases are observed.

In an effort to precisely determine the end member of the electrochemically induced Li–Ge phase, the discharged electrode was lithiated potentiostatically in two successive steps at 130 and 20 mV. These potential values correspond to the situations before and after the crystallization into Li$_{15}$Ge$_4$. The corresponding current (red curve) and charge (blue curve) responses are shown in the inset of Fig. 4. A decrease of the current during both potentiostatic steps is found, indicating that the insertion reactions proceed relatively rapidly. The corresponding XRD results are presented in the main graph of Fig. 4. The XRD patterns of the as-deposited (blue curve) and discharged (red curve) electrode are included as references. Taking a closer look at the pattern of the as-deposited sample, a strong (111) preferred orientation of the titanium nitride crystallites is found at $36.5^\circ$ 2$\Theta$. Interestingly, the discharged electrode reveals a weaker (111) intensity and a reflection of the [200] lattice planes is now visible at $42.5^\circ$ 2$\Theta$. The modification of the titanium nitride crystallites orientation probably results from the stress induced by the expansion/shrinkage of the germanium layer onto the underlying titanium nitride.

**Figure 2.** Cyclic voltammograms of a 50 nm thick evaporated Ge film at various insertion cutoff potentials. The scan rate is 50 $\mu$V s$^{-1}$ and the upper cutoff potential is 2 V in all cases.

**Figure 3.** In situ XRD characterization of a 200 nm thick evaporated Ge film. (a) Galvanostatic insertion and deinsertion of the film. The inset is a magnification of the potential curve at low voltages. Each marker represents the start of an XRD measurement. (b) XRD patterns corresponding to insertion. (c) XRD patterns corresponding to deinsertion. The reference patterns for TiN (blue) and Li$_2$Ge$_2$ (orange) are indicated as bars.
Regarding the phase transformations occurring within the germanium film, the pattern collected at the end of the first potentiostatic step at 130 mV (blue curve in Fig. 4), which corresponds to the situation when Li$_{15}$Ge$_4$ has not yet been formed, does not reveal any peaks associated with Li–Ge phases. This is in accordance with the constant current measurements presented in Fig. 3. When the potential is decreased to 20 mV, the material rapidly shows an XRD signature of Li$_7$Ge$_2$, as observed from the pattern collected at the start of the second potentiostatic step (red curve). The pattern collected at the end of the potentiostatic step at 20 mV (black curve) does not show any additional reflections. In addition, the charge transferred to the germanium layer between the two XRD patterns taken at 20 mV is negligible. From these results, it can be concluded that no other crystalline Li–Ge phases are formed before and after the crystallization into Li$_7$Ge$_2$.

A thicker evaporated germanium layer (500 nm) was also investigated with in situ XRD. Using a thicker film can be useful in revealing the formation of crystalline phases with weak diffraction intensities. As presented in the inset of Fig. 5, the sample was galvanostatically charged with a current of less than a 1/40 C rate to ensure full lithiation. The main graph of Fig. 5 shows the diffraction pattern measured just before the plateau at the end of the charging process [blue curve denoted as (a)] and the pattern measured after full lithiation [red curve denoted as (b)], as indicated by the markers in Fig. 5. Before the plateau, no diffraction peaks, except that of titanium nitride, are visible. After full lithiation, until the cell potential reached 0 V, peaks related to cubic Li$_7$Ge$_2$ are observed. The intensity of the peaks resulting from a 500 nm thick layer is obviously substantially increased. To conclude, other Li–Ge crystalline phases are not clearly observed for evaporated germanium thin films.

The thermodynamic and kinetic properties of evaporated germanium are presented in Fig. 6. Because the crystallization of germanium into Li$_{15}$Ge$_4$ induces relatively different potential profiles (cf. Fig. 2), the equilibrium curves were measured with GITT for two cutoff potentials, i.e., 50 (orange curve) and 0 mV (blue curve) (Fig. 6a). Upon insertion, several slopes are observed from 650 to 115 mV up to a Li/Ge ratio of about 3.69 Li/Ge, which probably represent XRD-amorphous transformation(s) (cf. Fig. 3). When the potential is restricted to 50 mV during current flowing conditions, the discharge curve also reveals several sloping parts (blue curve) ultimately leading to a reversible Li/Ge ratio of about 3.57 Li/Ge. When the electrode is fully inserted up to 0 V, the Li/Ge ratio increases to about 3.85. As a result, crystallization into Li$_{15}$Ge$_4$ occurs. The Li extraction of the electrode from Li$_{15}$Ge$_4$ material is represented by two rather flat plateaus until the composition reaches about 1.85 Li/Ge (orange curve). Upon further Li extraction, a sloping profile is again observed until the full extraction of Li from Ge occurs. This full extraction leads to a reversible Li/Ge ratio of about 3.75 Li/Ge. The inset of Fig. 6a shows the derivative of the Li/Ge ratio with respect to the potential. Obviously, the shape of the derivatives is very similar to the cyclic voltammograms in Fig. 2. During equilibrium, however, the potential is not influenced by the overpotentials and the delithiation peaks are therefore found at somewhat more negative potentials (390 and 450 mV). The flat plateaus observed during discharge are attractive in view of making batteries with more stable cell voltages. However, crystallization of the material may shorten the lifetime of the electrode as it induces severe local stresses at the boundaries between the amorphous and crystalline domains. Nevertheless, this may not be a critical issue if an appropriate thickness with a good adhesion to the substrate is realized. Moreover, limiting the extraction of Li from the electrode material by restricting the discharge cutoff potential may further improve the electrode lifetime (results not presented here). Indeed, one can very well imagine that a smaller shrinkage of the electrode is achieved when the amount of extracted Li is limited, which in turn increases the material lifetime.

The kinetics of evaporated germanium was investigated with EIS during a GITT discharge of Li$_{15}$Ge$_4$. The corresponding Nyquist plots are shown in Fig. 6b. The impedance results show two depressed semicircles followed by a straight line. The width of the semicircle observed at high frequencies in Fig. 6b is almost constant with respect to the potential and can therefore be attributed to an ionic conductor. The second semicircle is somewhat dependent on the potential and can be attributed to a charge-transfer process. The almost straight line observed at lower frequencies can certainly be related to the diffusion of Li species within the electrode material.
A schematic representation of this electrochemical system and the corresponding equivalent circuit are presented in Fig. 7a. The equivalent circuit includes two series resistances for the ohmic contacts on both electrode sides \( R_s \) and \( R_{a1} \), a liquid electrolyte \( (R_{lec}||C_{elec}) \), an SEI \( (R_{SEI}||C_{SEI}) \), a charge transfer \( (R_{ct} \text{ and } C_{dl}) \), and a diffusion element \( (Z_{diff}) \) response. The resistance \( R_{elec} \) represents the ionic resistance of the liquid electrolyte between the reference and working electrodes, and \( C_{elec} \) the corresponding geometric capacitance. The resistance \( R_{SEI} \) represents the ionic resistance of the SEI film and \( C_{SEI} \) the corresponding geometric capacitance. The charge transfer \( (R_{ct} \text{ and } C_{dl}) \) and diffusion are represented by a classical Randles circuit into which the Warburg element is substituted by a diffusion element \( (Z_{diff}) \) that can describe any type of diffusion process.

The very high-frequency domain (>50 kHz) is normally dominated by the liquid electrolyte response and the low-frequency domain by the diffusion of lithium within the host material. These two domains are not of direct interest for the present study and the following simplifications have been made. The straight line observed at frequencies lower than 10 Hz in Fig. 6b and making an angle smaller than 90° with the x-axis can be represented by an \( R||C \) component in which \( R \) has a relatively large value. As the low-frequency limit of the EIS experiments was set to 100 mHz, a good approximation of the straight line can be done by adopting a constant phase element \( (CPE_{elec}) \). Moreover, the response of the liquid electrolyte above 50 kHz \( (R_{elec}||C_{elec}) \) can be restricted to a resistor which represents the ionic resistance between the working and reference electrodes. This resistance can be included with the ohmic contact \( R_{s1} \) and \( R_{s2} \) resistances into the purely resistive component \( R_s \).

The depressed semicircle observed at high frequency (5 kHz) in Fig. 6b is related to ionic conduction as it is almost independent of...
the equilibrium potential. Therefore, it certainly represents the ionic conduction through an SEI layer. The somewhat more depressed semicircle measured at intermediate frequencies (300 kHz) certainly relates to a charge-transfer process, as it is potential-dependent. Thus, it is most probably representative of the charge transfer at the SEI/electrode interface. The roughness of the electrode [as observed for similar electrode systems by ex situ scanning electron microscopy] or in situ atomic force microscopy probably explains why the semicircles are somewhat depressed. As a result, CPEs were adopted instead of pure capacitors for the SEI (CPESEI) and double-layer (CPEdl) charge accumulation processes, as shown in the modified version of the equivalent circuit presented in Fig. 7a.

By fitting the experimental data shown in Fig. 6b with respect to the modified equivalent circuit shown in Fig. 7a, resistance, capacitance, and n values for the various components of the equivalent circuit were extracted. The results are summarized in Fig. 7b and c. The resistance and capacitance values associated with an ionic conductor are almost independent of the Li composition. The capacitance is between 1.3 and 1.9 F g⁻¹ for an electrode having a footprint geometry of 2 cm². This is characteristic of a solid ionic conductor and certainly results from an SEI layer, similarly to what has been reported for poly-Si electrodes. The double-layer capacitance is almost constant for compositions up to 2.5 Li/Ge (about 50 μF) and increases for higher Li compositions up to 90 μF for the highest Li content. This increase certainly results from a more complicated fit, as can also be concluded from the corresponding n values. The charge-transfer resistance decreases with increasing Li content (Fig. 7b). This is analogous to the poly-Si system. In addition, low values of Rcs are obtained, which implies that the rate at which electrons are transferred at the germanium/SEI interface is relatively fast.

The beneficial charge-transfer properties are further illustrated by measuring the rate capability of evaporated germanium during delithiation. The fully lithiated germanium electrode, i.e., Li15Ge4, was discharged from a 0.1–100 C rate (Fig. 8). Similar potential profiles and high capacities are obtained for all currents up to a 100 C rate, which indicates the very favorable rate capability of these germanium thin film electrodes. These results confirm the beneficial charge-transfer kinetics previously observed with EIS, and also indicate that the solid-state diffusion of lithium within these thin germanium films is quite favorable.

The difference of the electrochemical deinsertion response between evaporated and sputtered germanium thin films (50 nm) is visualized in Fig. 9. During insertion of Li, similar peaks are observed for both materials, which certainly indicates that evaporated and sputtered germanium undergo the same insertion reactions with Li. However, the peak positions are slightly different, particularly for the two small peaks observed at the end of the lithiation process. This difference can either originate from different equilibrium potentials (thermodynamics) or charge transfer, nucleation, or diffusion overpotentials (kinetics), which must be related to different material structures and defect densities. Upon extraction of Li from the fully lithiated material, sputtered germanium shows a sharp and intense peak at about 495 mV, while evaporated germanium presents the double-peak response. The reason for this difference is not clear yet. It probably results from differences in structural ordering, similar to what is observed during insertion.

The differences between evaporated and sputtered germanium, as observed in Fig. 9, has also been investigated in situ XRD. Figure 10a shows the constant current charge and discharge profile of a 200 nm thick sputtered film. A small and flat plateau is again observed at the beginning of charging at around 0.6 V. It can be attributed to the SEI formation, as reported by others. Upon (de)insertion, reactions similar to the cyclic voltammogram shown in Fig. 9 are observed. XRD patterns were collected during (de)insertion. Figure 10b shows the XRD patterns taken at the end of the insertion and at the start of the deinsertion process, as indicated by the markers in Fig. 10a. No diffraction peaks, except that of titanium nitride, are visible before the plateau observed at the end of charging. Once the plateau is reached, only diffraction peaks of the Li15Ge4 cubic phase are observed. This situation is similar to that of evaporated germanium, where only diffraction peaks resulting from Li15Ge4 are measured. This composition means that the maximum storage capacity of germanium thin-film electrodes is 1385 mAh g⁻¹ or 7366 mAh cm⁻³ of the starting material. Unfortunately, XRD could not reveal a difference in reaction between evaporated and sputtered germanium with Li ions. Therefore, more in-depth research is required. This could be achieved by means of advanced investigation techniques that are able to describe amorphous media, for instance extended X-ray absorption fine structure or nuclear magnetic resonance.

Conclusions

The thermodynamic and kinetic properties of evaporated germanium were investigated by means of conventional electrochemical tools. Evaporated and sputtered germanium thin films were investigated by means of in situ XRD to reveal the formed crystalline phases and the end member of the Li–Ge electrochemical system. The electrochemical equilibrium and impedance data suggest that evaporated germanium is a promising candidate as a lithium-ion negative electrode thin-film material. The in situ XRD results show that both types of germanium crystallize into cubic Li15Ge4 at full lithiation. The difference in reaction observed between evaporated and sputtered germanium could not be revealed using in situ XRD and needs to be investigated further. Nevertheless, it can be con-
cluded from this study that the end member of the Li–Ge electrochemical thin-film system is Li$_{15}$Ge$_4$. This composition means that the maximum storage capacity of germanium thin-film electrodes is 1385 mAh g$^{-1}$ or 7366 mAh cm$^{-3}$ of the starting material.

Figure 10. In situ XRD characterization of a 200 nm thick sputtered Ge film. (a) Galvanostatic insertion and deinsertion of the electrode. The inset is a magnification of the potential curve. Each marker represents the start of an XRD scan. (b) XRD patterns before and after the plateau visible at low potentials, corresponding to the markers shown in (a). The reference patterns for TiN (blue) and Li$_{15}$Ge$_4$ (orange) are indicated as bars.

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